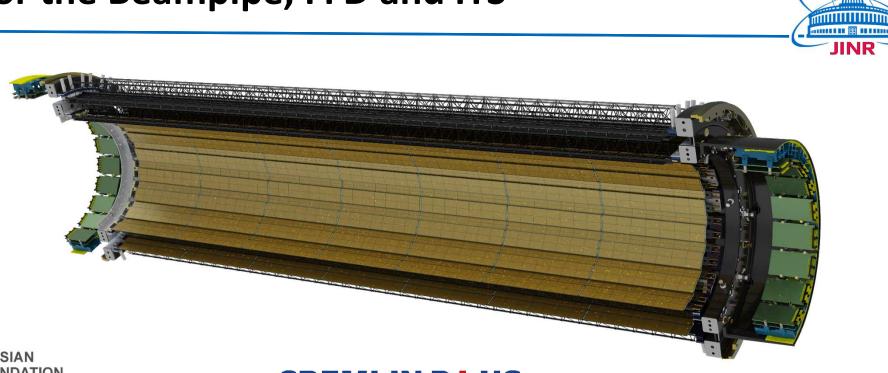


Status of mechanics for the Beampipe, FFD and ITS

Yuri Murin, JINR





Grant Agreement No. 18-02-40119





This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No. 871072



- > The MPD ITS structure in a nutshell
- > Problems with installation and the IC solution to those
- > Scenario of integration of the IC with the TPC with the help of the Interceptor
- Some 3D pictures beloved by the funding agencies
- Current status of design and production
- > Reserved promises on timelines for completion

The OB as the goal of the first stage of the ITS project

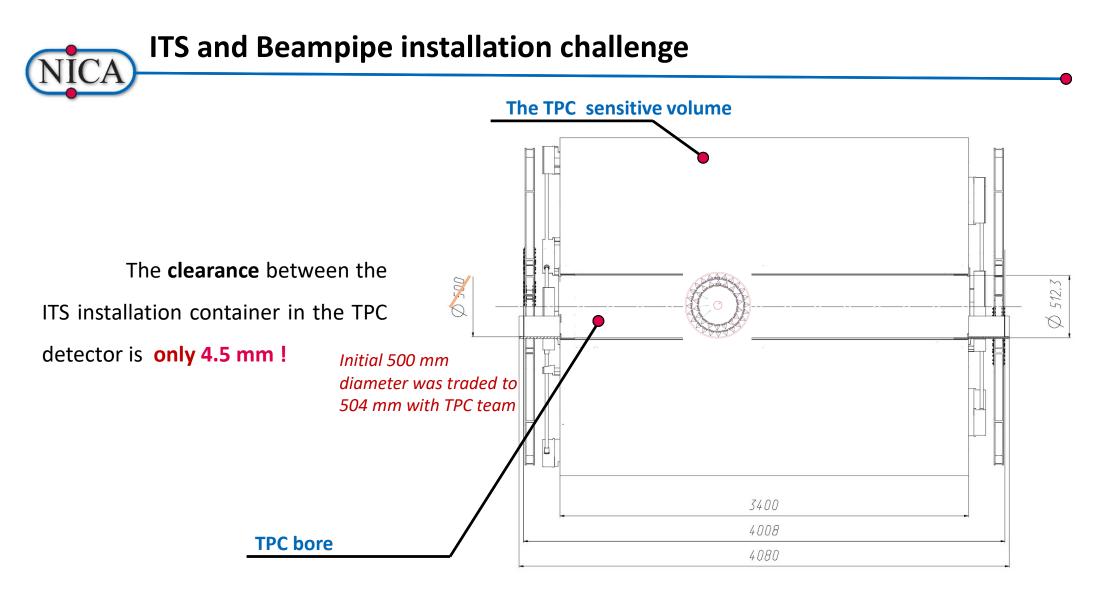
- Two Outer Barrel 2 layers composed of 42 staves each carrying 196 ALTAI chips of 15x30 mm² size ٠
- Radial position (mm): 145, 195; ٠
- Length in Z: 1475 mm; ٠

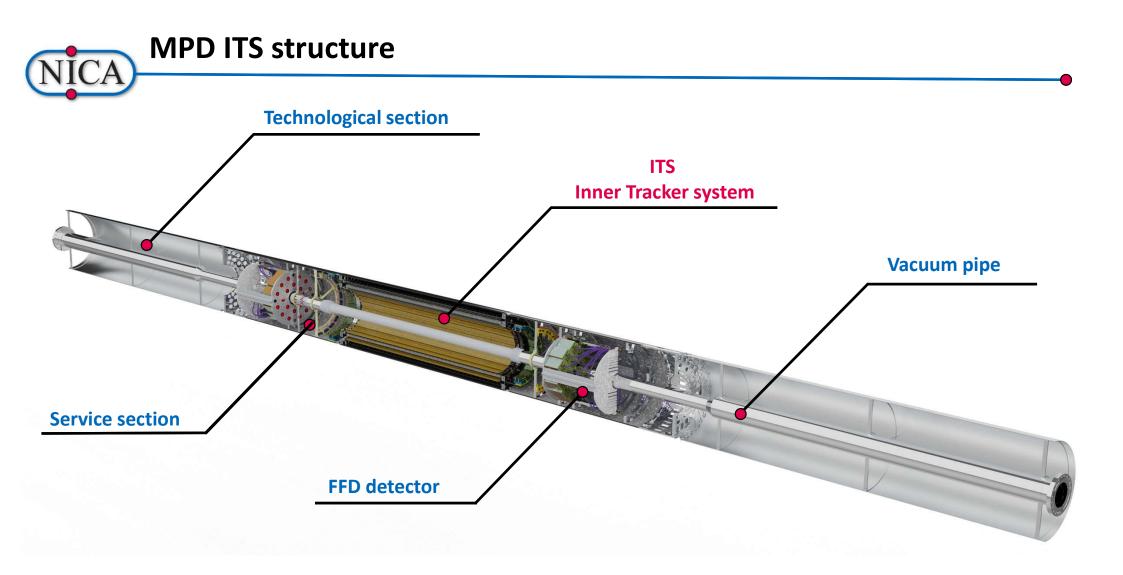
Light-weight caging

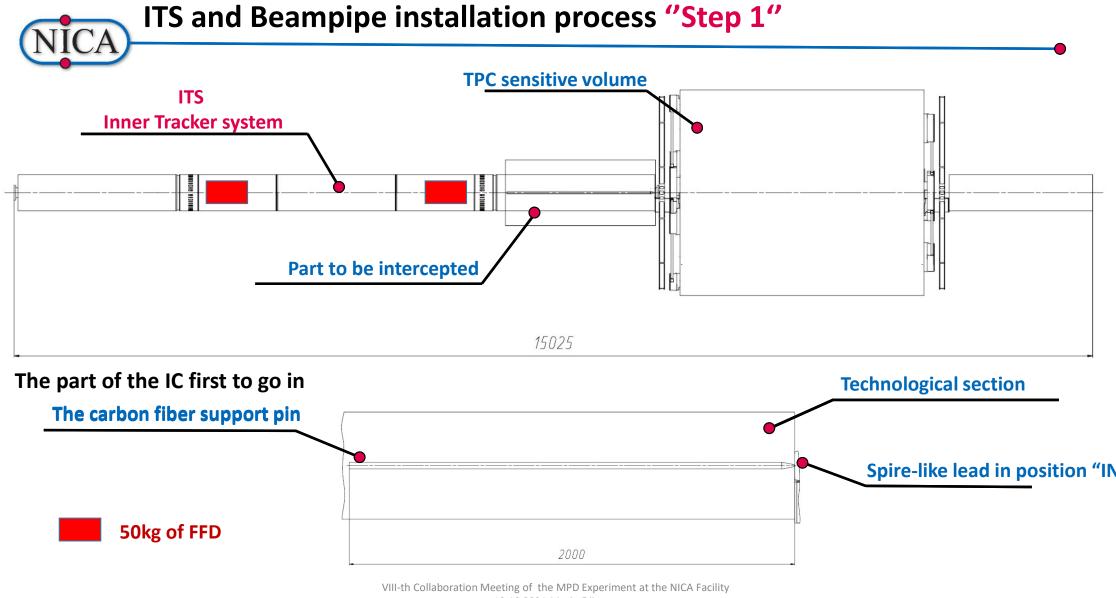
- Layer 4: 18 STAVEs / Layer 5: 24 STAVEs ٠
- 8232 MAPS cover 3,7 m² with 4'316B pixels ٠

Diameter of the ITS caging Is 495 mm

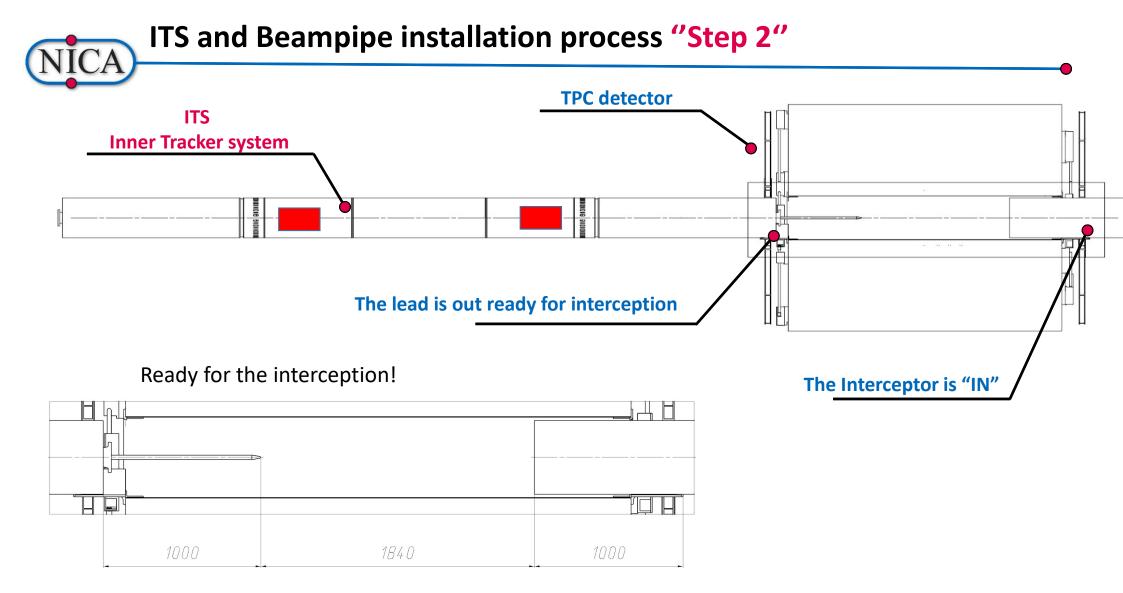
Light-weight CF trusses Hollow CF end-wheels

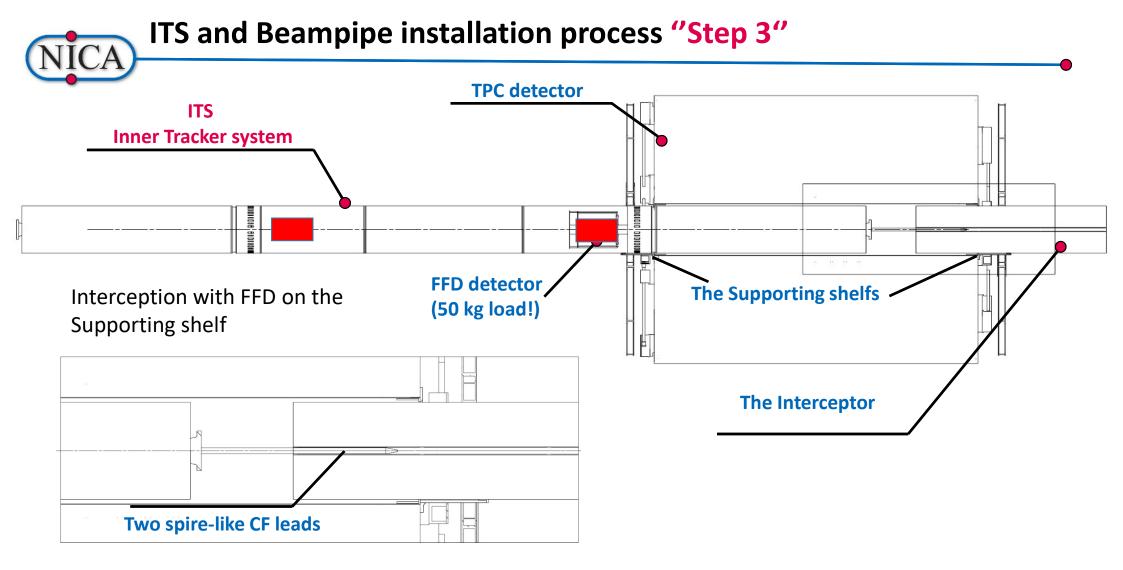




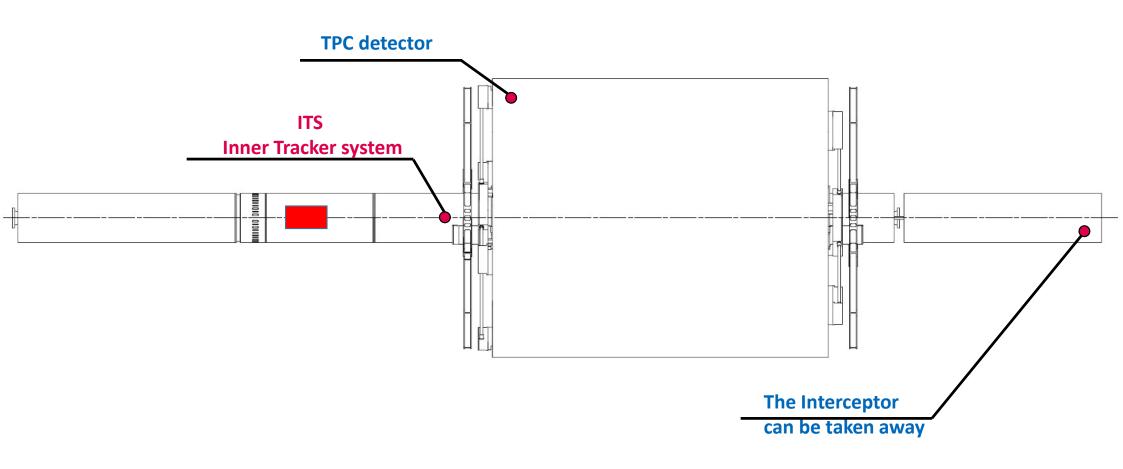


13.10.2021 Murin@jinr.ru

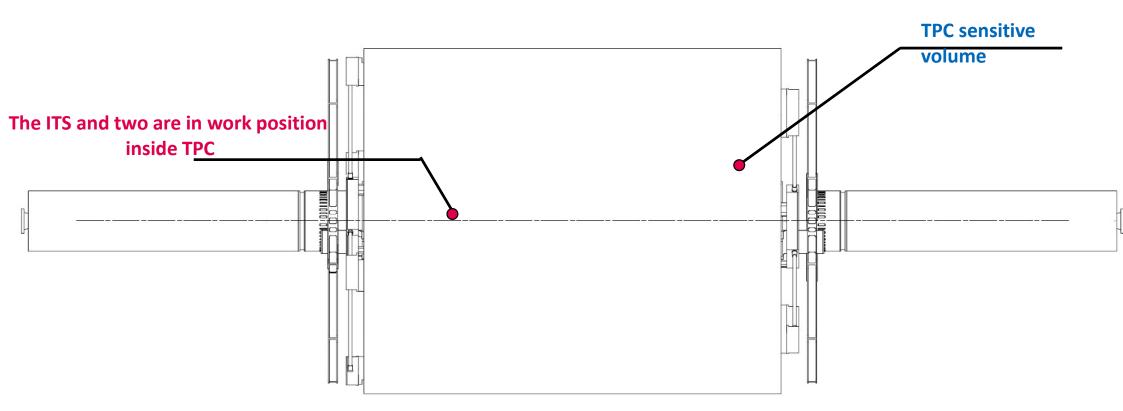






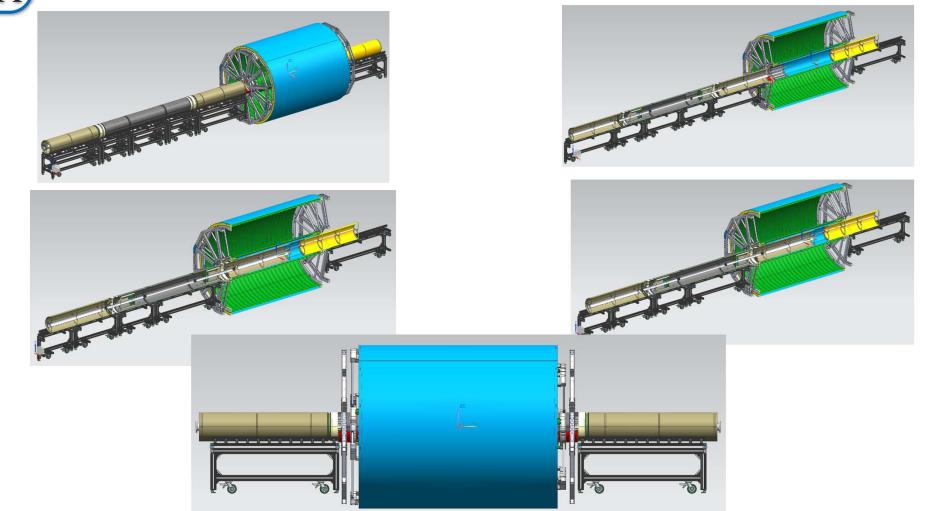




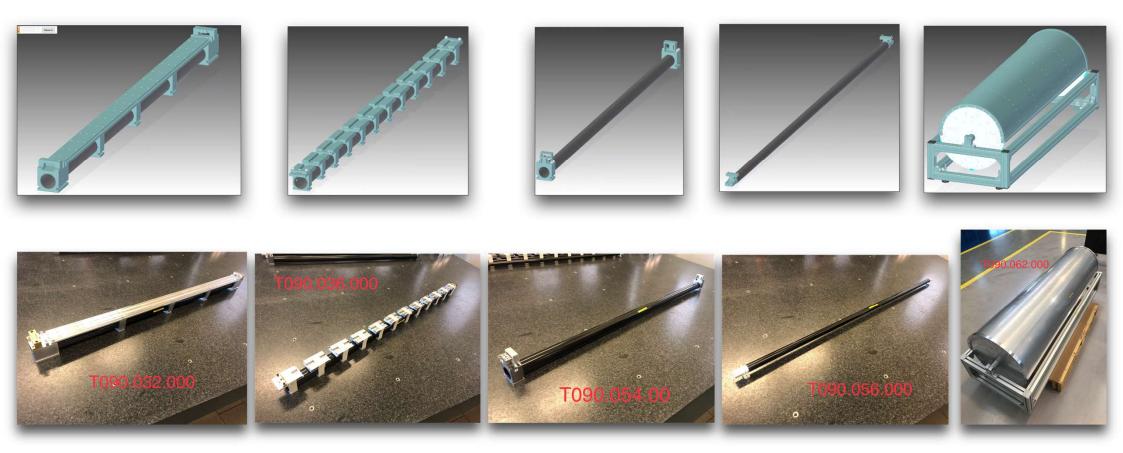


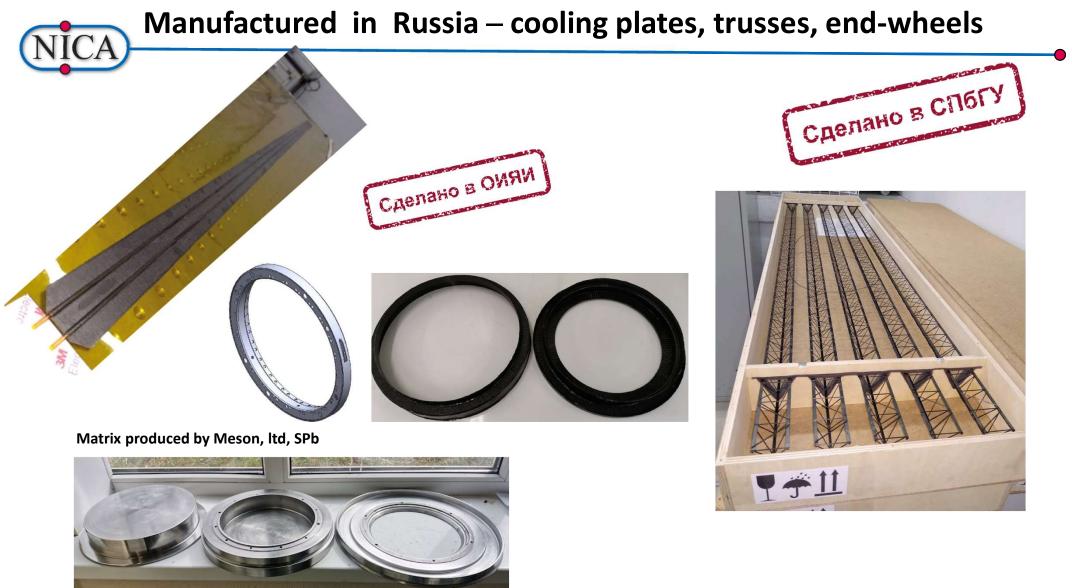


3D models before the final drawings with specifications









Parts already designed & Parts of on-going design with production in the house and outside

- > The installation tables (production in the house)
- > The CF casings and connectors (production in the house and outside)
- > Hollow CF End-Wheels (production in the house)
- > The metallic casing for the technological sections (production outside)
- BP support carriers (design after delivery of the BP prototype)
- The IC flip-latch jigs and fixtures (not yet started)
- > Metrology issues (Contract with "Industrial measurements, Itd")



Try tests of the IC integration and installation – Q1, 2023



